

Special Issue

Selected Papers from the 2016 International Conference on Nanoscience and Nanotechnology

Message from the Guest Editor

The 2016 International Conference on Nanoscience and Nanotechnology (N&N) was held in Frascati (Italy) from 26 to 29 September 2016. Since 2000, the conference has been an international meeting in the area of nanotechnology devoted to recent developments in nanoscience and its manifold technological applications. The conference contributions come from frontier nanoscience research developments and innovative nanotechnologies in the areas of biology, medicine, aerospace, optoelectronics, energy, materials and characterizations, low-dimensional nanostructures and devices.

Guest Editor

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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